

THE COMMISSIONER FOR PATENTS
Box 1450, Alexandria, VA 22313-1450

Docket No. MEG02-005

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: HUI-MEI CHEN, CHIEN-KANG CHOU, JIN-YUAN LEE, HSIEN-TSUNG LIU

For: METHOD FOR IMPROVING SEMICONDUCTOR WAFER TEST ACCURACY

Enclosed are:

3 sheets of drawing(s) - formal.

An assignment of the invention to **Magic Corporation**

An associate power of attorney Applicant claims small entity status

Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

(Col. 1)	(Col. 2)	SMALL ENTITY
FOR:	NO. FILED	NO. EXTRA
BASIC FEE		
TOTAL CLAIMS	14 -20=	0
INDEP CLAIMS	2 -3=	0
		RATE
		x 9 =
		\$ 385.
		\$ 0.
		x 43 =
		\$ 0.
		SUB TOTAL
		\$ 385.
		ASSIGNMENT
		\$40.
		TOTAL
		\$ 425.

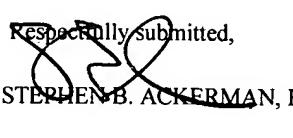
Please charge my Deposit Account No. 19-0033 in the amount of \$ 425. A duplicate copy of this sheet is enclosed.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.

Any additional filing fees required under 37 CFR §1.16.

Any patent application processing fees under 37 CFR §1.17.

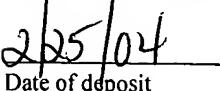
Respectfully submitted,


STEPHEN B. ACKERMAN, REG. NO. 37,761

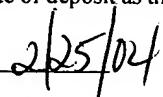
EXPRESS MAIL CERTIFICATE

Express Mail No. EV385357862US

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